

> Features

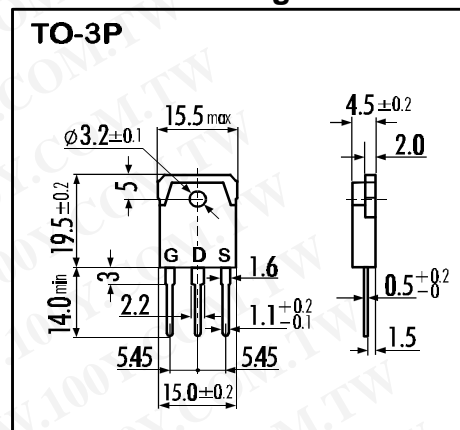
- Include Fast Recovery Diode
- High Voltage
- Low Driving Power

> Applications

- Motor Control
- Inverters
- Choppers

勝特力材料 886-3-5753170
 勝特力电子(上海) 86-21-34970699
 勝特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

> Outline Drawing

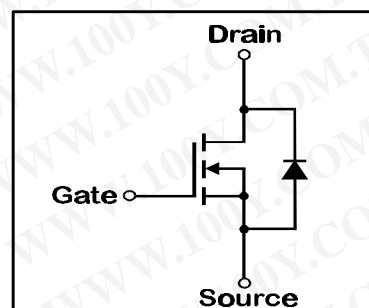


> Maximum Ratings and Characteristics

- Absolute Maximum Ratings ($T_C=25^\circ\text{C}$), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V_{DS}	250	V
Drain-Gate-Voltage ($R_{GS}=20K\Omega$)	V_{DGR}	250	V
Continous Drain Current	I_D	20	A
Pulsed Drain Current	$I_{D(puls)}$	80	A
Gate-Source-Voltage	V_{GS}	± 20	V
Max. Power Dissipation	P_D	100	W
Operating and Storage Temperature Range	T_{ch}	150	$^\circ\text{C}$
	T_{stg}	-55 ~ +150	$^\circ\text{C}$

> Equivalent Circuit



- Electrical Characteristics ($T_C=25^\circ\text{C}$), unless otherwise specified

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown-Voltage	$V_{(BR)DSS}$	$I_D=1\text{mA}$ $V_{GS}=0\text{V}$	250			V
Gate Threshold Voltage	$V_{GS(th)}$	$I_D=1\text{mA}$ $V_{DS}=V_{GS}$	2,1	3,0	4,0	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=250\text{V}$ $T_{ch}=25^\circ\text{C}$		10	500	μA
		$V_{GS}=0\text{V}$ $T_{ch}=125^\circ\text{C}$		0,5	2,0	mA
Gate Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20\text{V}$ $V_{DS}=0\text{V}$		10	100	nA
Drain Source On-State Resistance	$R_{DS(on)}$	$I_D=10\text{A}$ $V_{GS}=10\text{V}$		0,16	0,25	Ω
Forward Transconductance	g_{fs}	$I_D=10\text{A}$ $V_{DS}=25\text{V}$	6	12		S
Input Capacitance	C_{iss}	$V_{DS}=25\text{V}$		1100	1600	pF
Output Capacitance	C_{oss}	$V_{GS}=0\text{V}$		240	360	pF
Reverse Transfer Capacitance	C_{rss}	$f=1\text{MHz}$		130	200	pF
Turn-On-Time t_{on} ($t_{on}=t_{d(on)}+t_r$)	$t_{d(on)}$	$V_{CC}=150\text{V}$		30	45	ns
		$I_D=20\text{A}$		50	80	ns
Turn-Off-Time t_{off} ($t_{off}=t_{d(off)}+t_f$)	$t_{d(off)}$	$V_{GS}=10\text{V}$		200	300	ns
		$R_{GS}=25\Omega$		100	150	ns
Avalanche Capability	I_{AV}	$L=100\mu\text{H}$ $T_{ch}=25^\circ\text{C}$	15			A
Continous Reverse Drain Current	I_{DR}				20	A
Pulsed Reverse Drain Current	I_{DRM}				80	A
Diode Forward On-Voltage	V_{SD}	$I_F=2I_{DR}$ $V_{GS}=0\text{V}$ $T_{ch}=25^\circ\text{C}$		0,95	1,8	V
Reverse Recovery Time	t_{rr}	$I_F=I_{DR}$ $V_{GS}=0\text{V}$		100	150	ns
Reverse Recovery Charge	Q_{rr}	$-di_F/dt=100\text{A}/\mu\text{s}$ $T_{ch}=25^\circ\text{C}$		0,35		μC

- Thermal Characteristics

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Thermal Resistance	$R_{th(ch-a)}$	channel to air			35	$^\circ\text{C}/\text{W}$
	$R_{th(ch-c)}$	channel to case			1,25	$^\circ\text{C}/\text{W}$

N-channel MOS-FET			
250V	0,25Ω	20A	100W

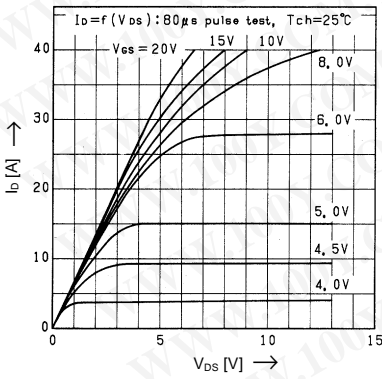
2SK1276A

F-V Series

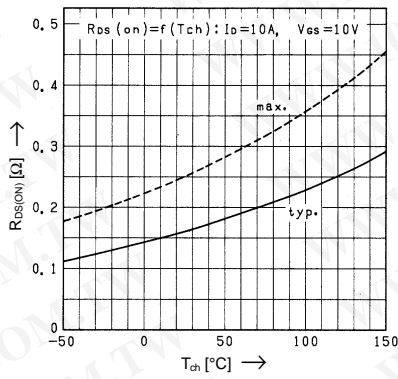


> Characteristics

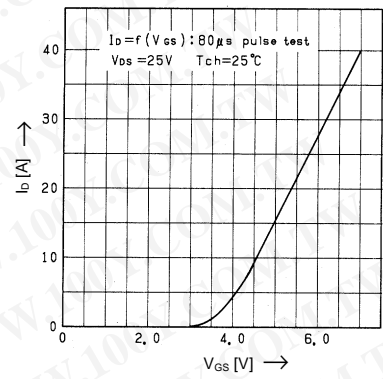
Typical Output Characteristics



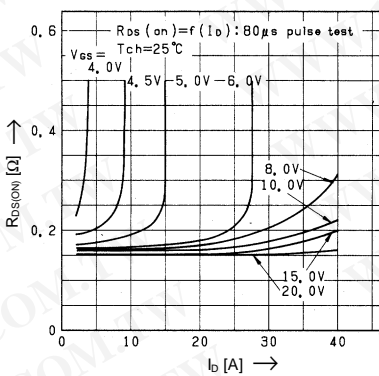
Drain-Source-On-State Resistance vs. T_{ch}



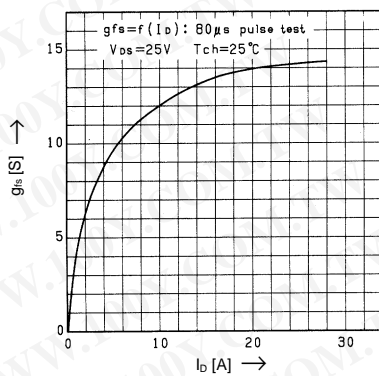
Typical Transfer Characteristics



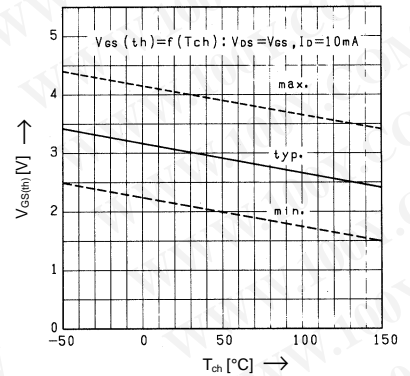
Typical Drain-Source-On-State-Resistance vs. I_D



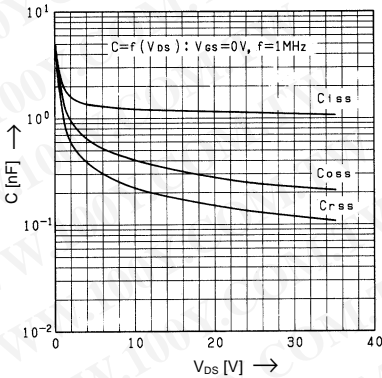
Typical Forward Transconductance vs. I_D



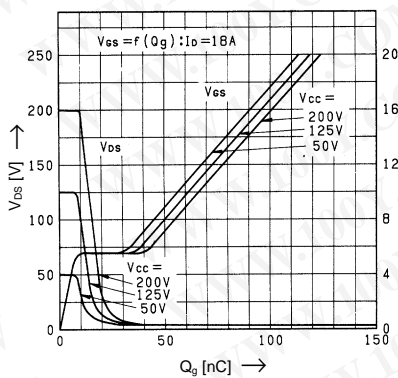
Gate Threshold Voltage vs. T_{ch}



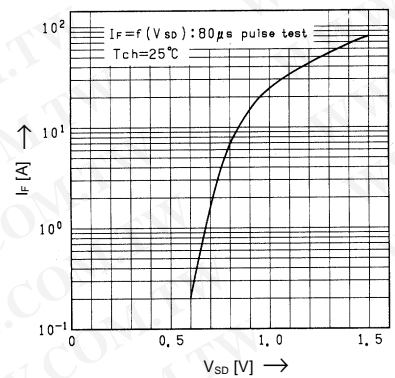
Typical Capacitance vs. V_{DS}



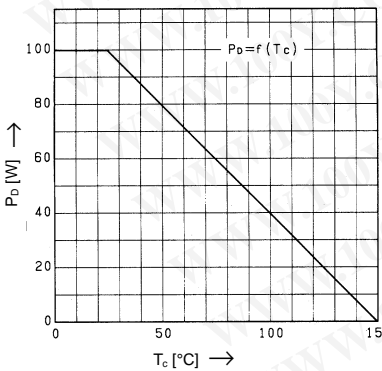
Typical Input Charge



Forward Characteristics of Reverse Diode



Allowable Power Dissipation vs. T_C



Safe operation area

